

### IRLZ34, SiHLZ34

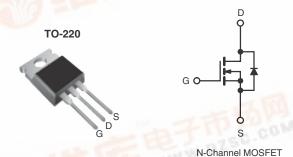
Vishay Siliconix

RoHS

COMPLIANT

# WWW.DZSC **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 5.0 V	0.050			
Q <sub>g</sub> (Max.) (nC)	35				
Q <sub>gs</sub> (nC)	7.1 C C C				
Q <sub>gd</sub> (nC)	25				
Configuration	Single				



#### **FEATURES**

- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- · Simple Drive Requirements
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

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ORDERING INFORMATION	7. 书协四
Package	TO-220
Lead (Pb)-free	IRLZ34PbF
	SiHLZ34-E3
SnPb	IRLZ34
	SiHLZ34

ABSOLUTE MAXIMUM RATINGS T	<sub>C</sub> = 25 °C, u	nless otherw	rise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	V	
Gate-Source Voltage			$V_{GS}$	± 10	V	
Continuous Drain Current	V <sub>GS</sub> at 5 V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	30	- 446	
		$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		21	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	110		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	- FA	07/1/0	E <sub>AS</sub>	220	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		P <sub>D</sub>	88	W	
Peak Diode Recovery dV/dtc	COM		dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	00	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	
Mounting Torque	6.00.0*1	C 00 av M0 aavan		10	lbf ⋅ in	
	6-32 or M3 screw			1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 285  $\mu$ H,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 30 A (see fig. 12).
- c.  $I_{SD} \le 30$  A,  $dI/dt \le 200$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- 7.6 mm from case.

Po containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7	

PARAMETER	SYMBOL	TEST (	MIN.	TYP.	MAX.	UNIT	
Static		1			•	l.	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.070	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		1.0	-	2.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 10 V		ı	-	± 100	nA
Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V		$80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	ı	-	25	,,,
Zero Gate Voltage Drain Guirent	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V	<sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	1	-	250	μA
Drain Source On State Resistance	D	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 18 A <sup>b</sup>	1	-	0.050	Ω
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 15 A <sup>b</sup>	ı	-	0.070	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 25 V, I <sub>D</sub> = 18 A <sup>b</sup>		12	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		ı	1600	-	pF
Output Capacitance	$C_{oss}$			1	660	-	
Reverse Transfer Capacitance	$C_{rss}$			ı	170	-	
Total Gate Charge	$Q_g$		I <sub>D</sub> = 30 A, V <sub>DS</sub> = 48 V - see fig. 6 and 13 <sup>b</sup> -	-	-	35	nC
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 5.0 \text{ V}$		ı	-	7.1	
Gate-Drain Charge	$Q_{gd}$			-	-	25	
Turn-On Delay Time	t <sub>d(on)</sub>				14	-	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $I_{D}$ = 30 A $R_{G}$ = 6.0 $\Omega$ , $R_{D}$ = 1.0 $\Omega$ , see fig. 10 <sup>b</sup>		-	170	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	30	-	
Fall Time	t <sub>f</sub>			-	56	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	30	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			ı	-	110	
Body Diode Voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = 30$ A, $V_{GS} = 0$ V <sup>b</sup>		-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 30 A, dl/dt = 100 A/μs <sup>b</sup>		-	120	180	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	0.70	1.3	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	on is dor	minated b	y L <sub>S</sub> and	 L <sub>D</sub> )	

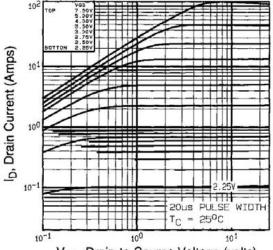
#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $V_{DS}$ , Drain-to-Source Voltage (volts) Fig. 1 - Typical Output Characteristics,  $T_C$  = 25 °C

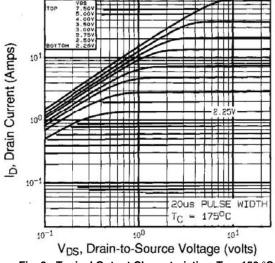
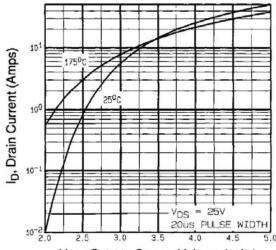


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C



V<sub>GS</sub>, Gate-to-Source Voltage (volts) Fig. 3 - Typical Transfer Characteristics

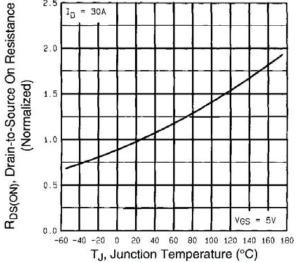


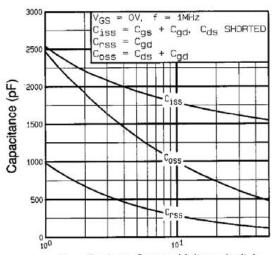
Fig. 4 - Normalized On-Resistance vs. Temperature

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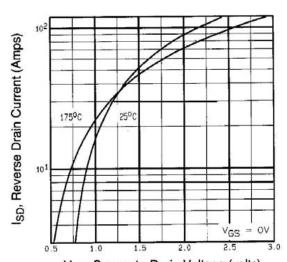
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V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



V<sub>SD</sub>, Source-to-Drain Voltage (volts) Fig. 7 - Typical Source-Drain Diode Forward Voltage

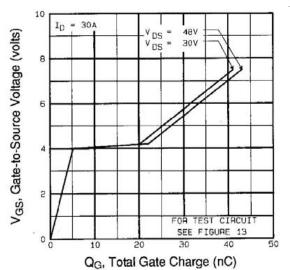


Fig. 6 - Typical Gate Charge vs. Drain-to-Source Voltage

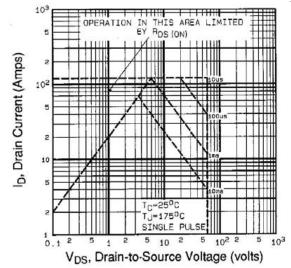
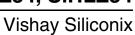


Fig. 8 - Maximum Safe Operating Area

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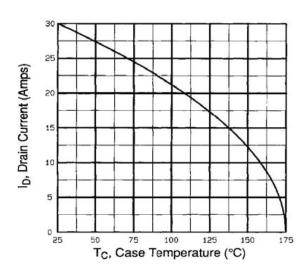


Fig. 9 - Maximum Drain Current vs. Case Temperature

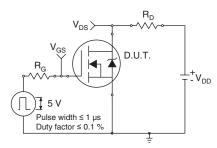


Fig. 10a - Switching Time Test Circuit

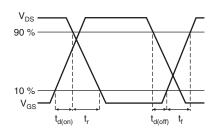


Fig. 10b - Switching Time Waveforms

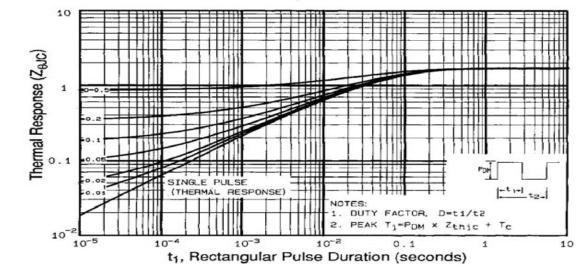


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

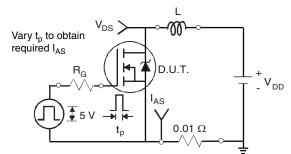


Fig. 12a - Unclamped Inductive Test Circuit

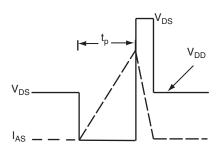


Fig. 12b - Unclamped Inductive Waveforms

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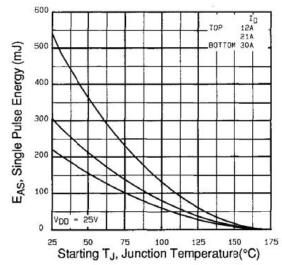


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

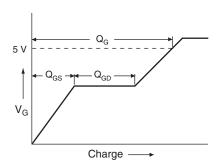


Fig. 13a - Basic Gate Charge Waveform

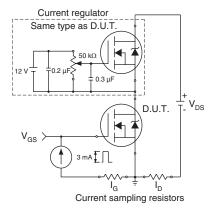


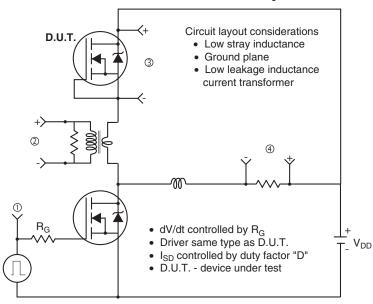
Fig. 13b - Gate Charge Test Circuit

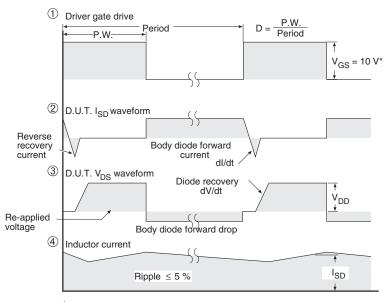
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### Peak Diode Recovery dV/dt Test Circuit





\* V<sub>GS</sub> = 5 V for logic level devices

Fig. 14 - For N-Channel

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